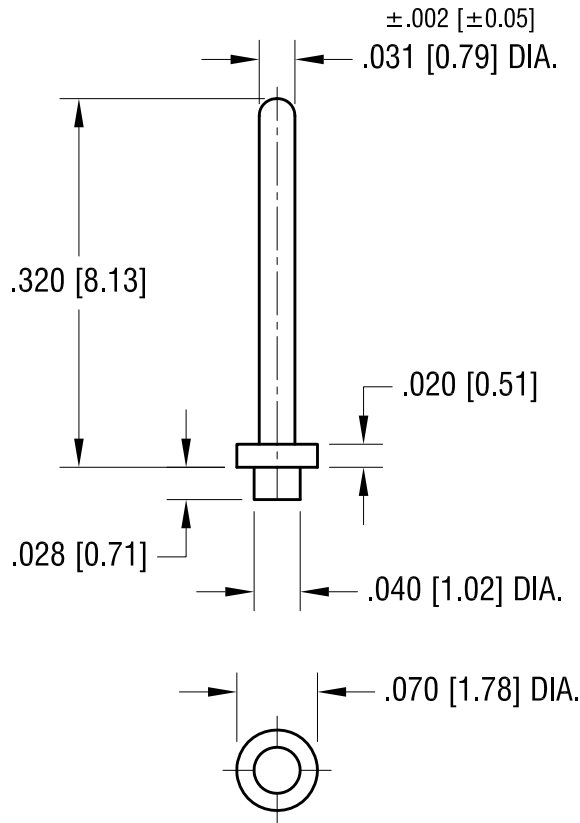


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ACTUAL SIZE



NOTE:
1. MOUNTING HOLE .043 [1.09] DIA.

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PART NAME		MICRO PIN, SOLDER MOUNT	
MATERIAL		BRASS	
FINISH		DRN BY	DATE
GOLD PLATE		BOONE	2.22.07
		APP'D	SCALE
		LN	6X
TOLERANCES		INCH	[MM]
DECIMAL		± .005	[± 0.13]
ANGULAR		± 1°	
UNLESS OTHERWISE SPECIFIED		CODE	DWG NO.
		C	1352-1

4.16.08	CHANGE AS PER ECN 08-101	A
DATE	DESCRIPTION	REV.